

## General Description

The WST3403 is the highest performance trench P-Ch MOSFET with extreme high cell density, which provide excellent R<sub>DS(on)</sub> and gate charge for most of the small power switching and load switch applications.

The WST3403 meet the RoHS and Green Product requirement with full function reliability approved.

## Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent C<sub>dv/dt</sub> effect decline
- Green Device Available

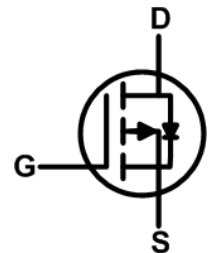
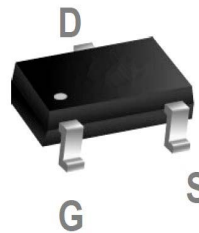
## Product Summary

| BVDSS | R <sub>DS(on)</sub> | I <sub>D</sub> |
|-------|---------------------|----------------|
| -30V  | 60mΩ                | -3.5A          |

## Applications

- High Frequency Point-of-Load Synchronous Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

## SOT-23N Pin Configuration



## Absolute Maximum Ratings

| Symbol                               | Parameter                                                      | Rating     | Units |
|--------------------------------------|----------------------------------------------------------------|------------|-------|
| V <sub>DS</sub>                      | Drain-Source Voltage                                           | -30        | V     |
| V <sub>GS</sub>                      | Gate-Source Voltage                                            | ±20        | V     |
| I <sub>D</sub> @T <sub>c</sub> =25°C | Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup> | -3.5       | A     |
| I <sub>D</sub> @T <sub>c</sub> =70°C | Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup> | -2.5       | A     |
| I <sub>DM</sub>                      | Pulsed Drain Current <sup>2</sup>                              | -15.5      | A     |
| P <sub>D</sub> @T <sub>A</sub> =25°C | Total Power Dissipation <sup>3</sup>                           | 1          | W     |
| T <sub>STG</sub>                     | Storage Temperature Range                                      | -55 to 150 | °C    |
| T <sub>J</sub>                       | Operating Junction Temperature Range                           | -55 to 150 | °C    |

## Thermal Data

| Symbol           | Parameter                                        | Typ. | Max. | Unit |
|------------------|--------------------------------------------------|------|------|------|
| R <sub>θJA</sub> | Thermal Resistance Junction-ambient <sup>1</sup> | ---  | 125  | °C/W |
| R <sub>θJC</sub> | Thermal Resistance Junction-Case <sup>1</sup>    | ---  | 80   | °C/W |

**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

| Symbol                              | Parameter                                      | Conditions                                                                                 | Min. | Typ.  | Max. | Unit  |
|-------------------------------------|------------------------------------------------|--------------------------------------------------------------------------------------------|------|-------|------|-------|
| BV <sub>DSS</sub>                   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA                                                | -30  | ---   | ---  | V     |
| ΔBV <sub>DSS</sub> /ΔT <sub>J</sub> | BVDSS Temperature Coefficient                  | Reference to 25°C, I <sub>D</sub> =-1mA                                                    | ---  | -0.01 | ---  | V/°C  |
| R <sub>DS(ON)</sub>                 | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3A                                                | ---  | 60    | 75   | mΩ    |
|                                     |                                                | V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2A                                                | ---  | 85    | 105  |       |
| V <sub>GS(th)</sub>                 | Gate Threshold Voltage                         | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA                                  | -0.5 | -0.7  | -1.2 | V     |
| ΔV <sub>GS(th)</sub>                | V <sub>GS(th)</sub> Temperature Coefficient    |                                                                                            | ---  | 2.98  | ---  | mV/°C |
| I <sub>DSS</sub>                    | Drain-Source Leakage Current                   | V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C                           | ---  | ---   | -1   | uA    |
|                                     |                                                | V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C                           | ---  | ---   | -5   |       |
| I <sub>GSS</sub>                    | Gate-Source Leakage Current                    | V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V                                                  | ---  | ---   | ±100 | nA    |
| g <sub>fs</sub>                     | Forward Transconductance                       | V <sub>DS</sub> =-5V, I <sub>D</sub> =-3A                                                  | ---  | 9     | ---  | S     |
| Q <sub>g</sub>                      | Total Gate Charge (-4.5V)                      | V <sub>DS</sub> =-10V, V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3A                         | ---  | 9.7   | 13.6 | nC    |
| Q <sub>gs</sub>                     | Gate-Source Charge                             |                                                                                            | ---  | 2.05  | 2.9  |       |
| Q <sub>gd</sub>                     | Gate-Drain Charge                              |                                                                                            | ---  | 2.43  | 3.4  |       |
| T <sub>d(on)</sub>                  | Turn-On Delay Time                             | V <sub>DD</sub> =-10V, V <sub>GS</sub> =-4.5V, R <sub>G</sub> =3.3Ω<br>I <sub>D</sub> =-3A | ---  | 4.8   | 9.6  | ns    |
| T <sub>r</sub>                      | Rise Time                                      |                                                                                            | ---  | 9.6   | 17.3 |       |
| T <sub>d(off)</sub>                 | Turn-Off Delay Time                            |                                                                                            | ---  | 52    | 104  |       |
| T <sub>f</sub>                      | Fall Time                                      |                                                                                            | ---  | 8.4   | 16.8 |       |
| C <sub>iss</sub>                    | Input Capacitance                              | V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V, f=1MHz                                         | ---  | 686   | ---  | pF    |
| C <sub>oss</sub>                    | Output Capacitance                             |                                                                                            | ---  | 90.8  | ---  |       |
| C <sub>rss</sub>                    | Reverse Transfer Capacitance                   |                                                                                            | ---  | 80.4  | ---  |       |

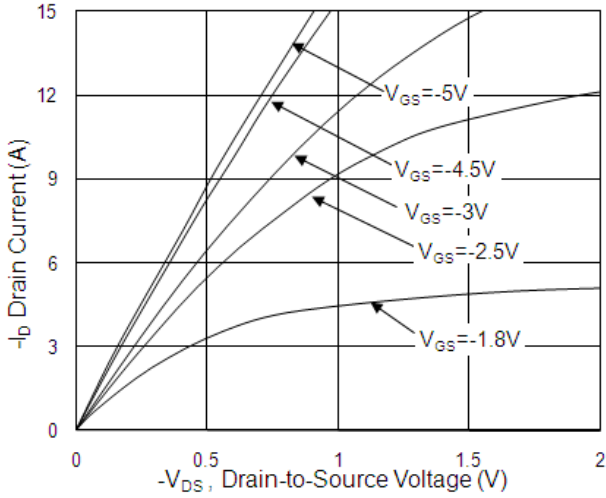
**Diode Characteristics**

| Symbol          | Parameter                                | Conditions                                                     | Min. | Typ. | Max.  | Unit |
|-----------------|------------------------------------------|----------------------------------------------------------------|------|------|-------|------|
| I <sub>S</sub>  | Continuous Source Current <sup>1,4</sup> | V <sub>G</sub> =V <sub>D</sub> =0V, Force Current              | ---  | ---  | -3.1  | A    |
| I <sub>SM</sub> | Pulsed Source Current <sup>2,4</sup>     |                                                                | ---  | ---  | -15.5 | A    |
| V <sub>SD</sub> | Diode Forward Voltage <sup>2</sup>       | V <sub>GS</sub> =0V, I <sub>S</sub> =-1A, T <sub>J</sub> =25°C | ---  | ---  | -1    | V    |
| t <sub>rr</sub> | Reverse Recovery Time                    | I <sub>F</sub> =-3A, dI/dt=100A/μs, T <sub>J</sub> =25°C       | ---  | 8.4  | ---   | nS   |
| Q <sub>rr</sub> | Reverse Recovery Charge                  |                                                                | ---  | 3.3  | ---   | nC   |

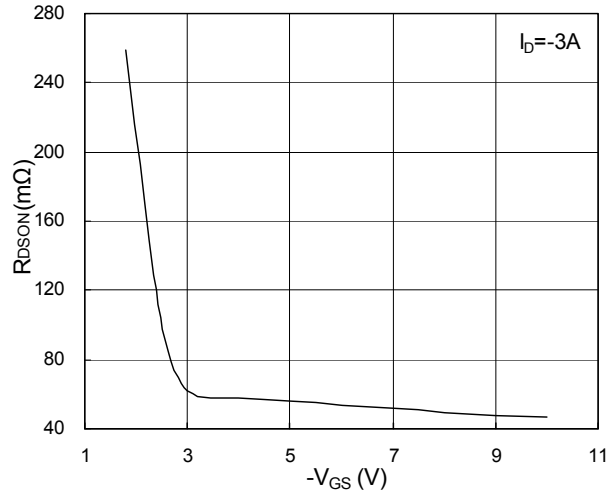
Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The power dissipation is limited by 150°C junction temperature
- 4.The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub> , in real applications , should be limited by total power dissipation.

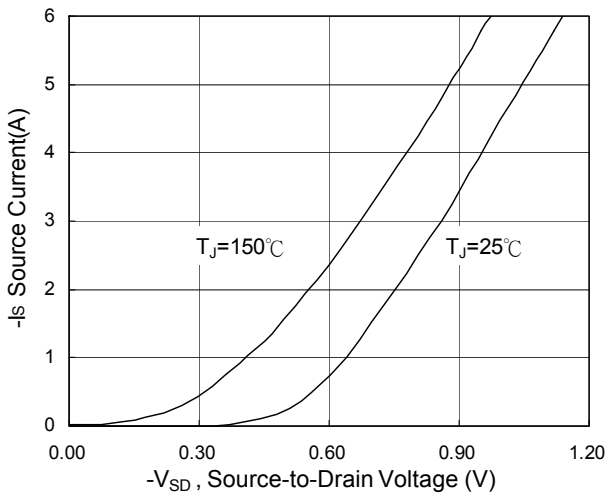
**Typical Characteristics**



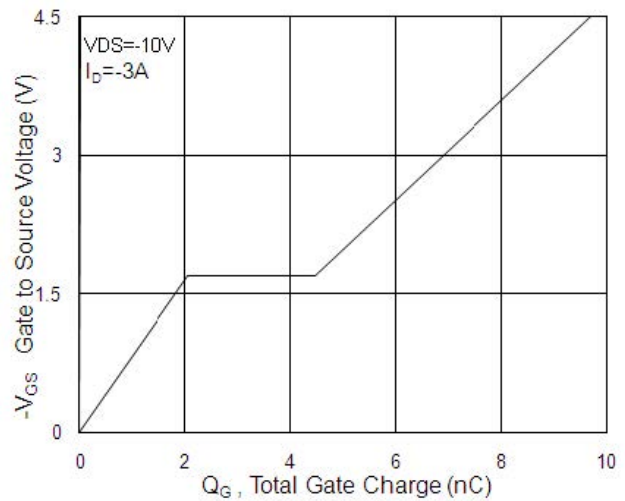
**Fig.1 Typical Output Characteristics**



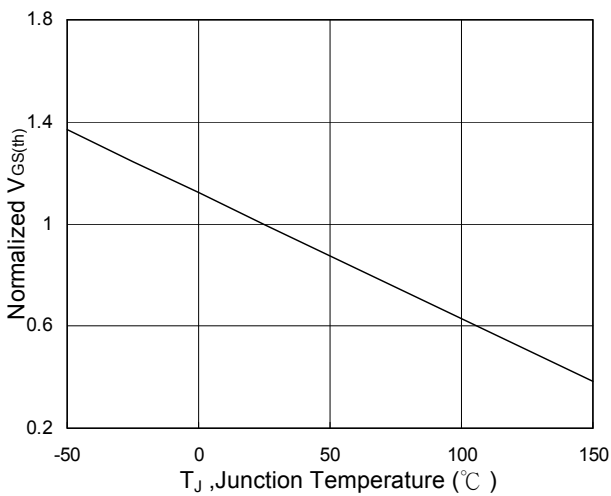
**Fig.2 On-Resistance vs. Gate-Source**



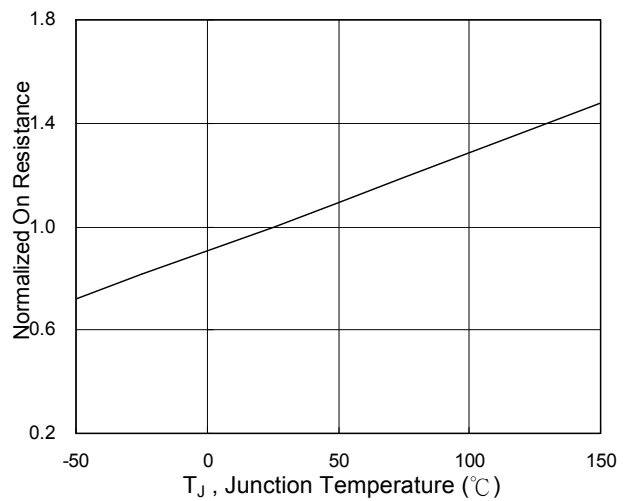
**Fig.3 Forward Characteristics Of Reverse**



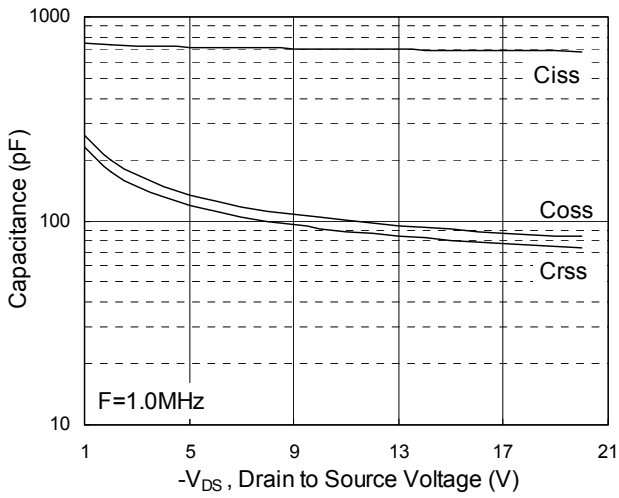
**Fig.4 Gate-Charge Characteristics**



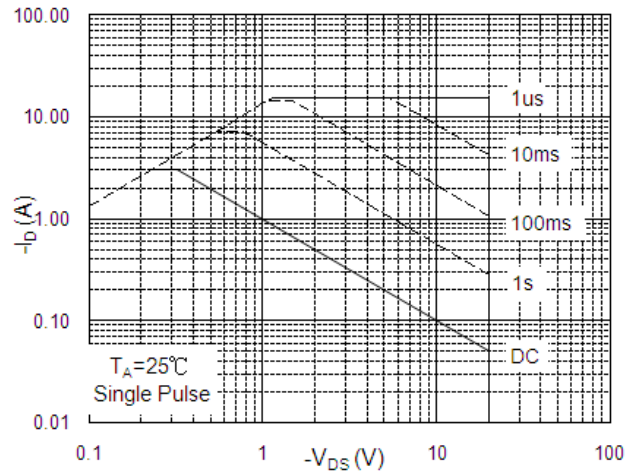
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



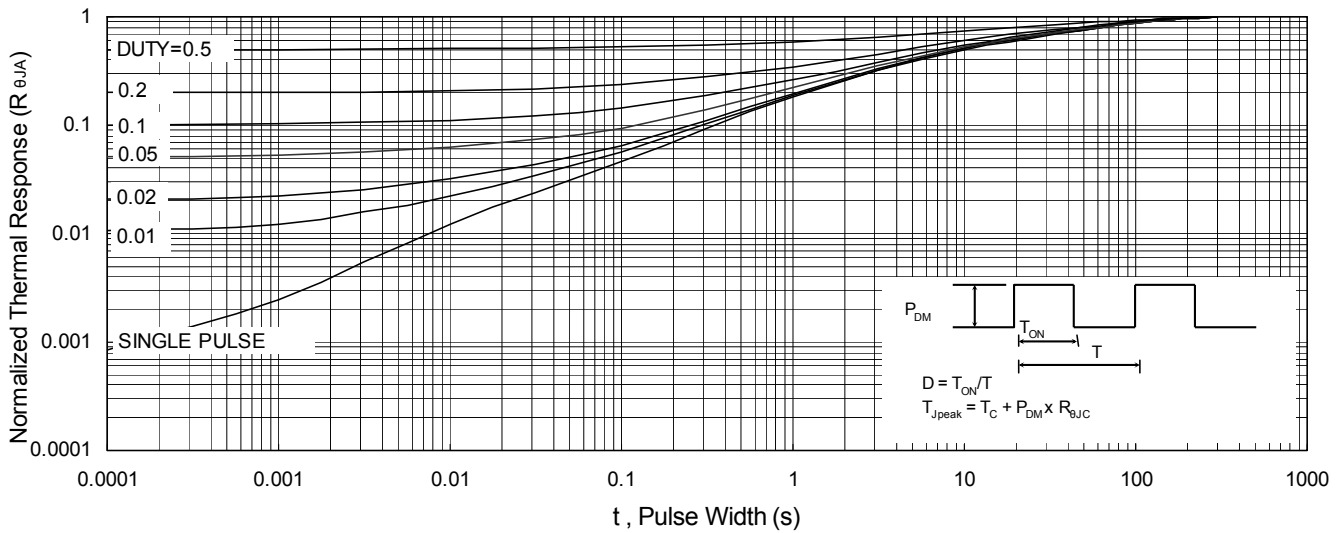
**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**



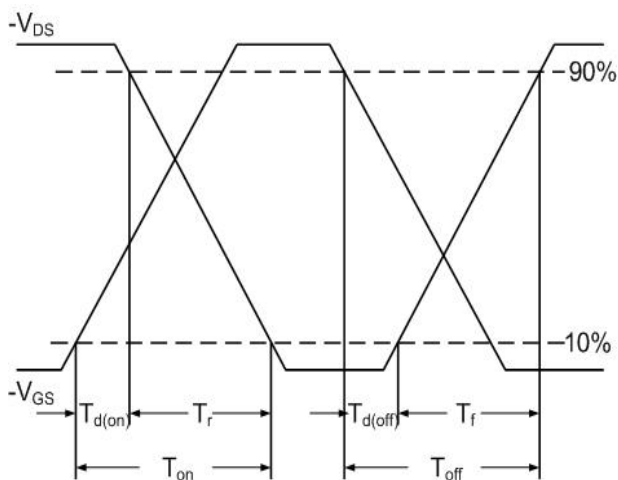
**Fig.7 Capacitance**



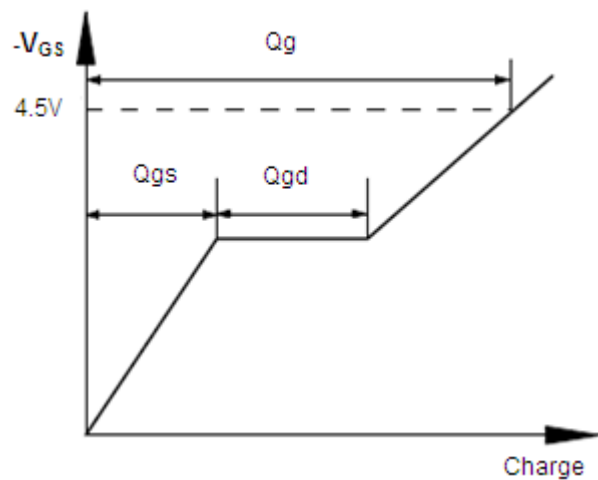
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**



**Fig.10 Switching Time Waveform**



**Fig.11 Gate Charge Waveform**



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